## WHAT IS CLAIMED IS:

An apparatus for reading a mark on a wafer, comprising:

 a support structure having a mark reading side and a wafer support side;
 means for illuminating said wafer; and
 means for reflecting light from said wafer.

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- 2. The apparatus of claim 1, wherein said mark reading side is a vertically oriented side and said wafer support side is positioned at an angle and contains at least one slot.
- 3. The apparatus of claim 2, wherein said at least one slot comprises a plurality of slots, each slot of said plurality of slots is spaced apart from an adjacent slot by at least a width of said wafer.
  - 4. The apparatus of claim 1, wherein said mark is a scribe mark.
- 15 5. The apparatus of claim 1, wherein said means for illuminating comprises one of a light emitting diode or ambient light.
  - 6. The apparatus of claim 1, wherein said means for reflecting light comprises a mirror material disposed on a surface of said wafer support side.

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- 7. The apparatus of claim 6, wherein said means for reflecting light comprises a mirror spaced apart from the mirror material.
- 8. The apparatus of claim 7, wherein said mirror is a concave mirror.

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- 9. An apparatus for reading a scribe mark on a wafer, said apparatus having no movable parts comprising:
- a body having first and second plates, said first plate having at least one slot formed therein; and
- a reflective material formed on a portion of said first plate.

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- 10. The apparatus of claim 9, further including a vertical support, wherein said vertical support couples said first plate to said second plate.
- 11. The apparatus of claim 9, wherein said reflective material is a mirror material.
- 12. The apparatus of claim 9, further including a mirror optically coupled to said mirror material.
- 13. The apparatus of claim 12, wherein said mirror is a concave mirror.
- 14. The apparatus of claim 9, further including a light source for providing light to be reflected to said mirror material.
- 15. The apparatus of claim 9, wherein said light source is a diode.
- 16. A method for reading a mark on a semiconductor wafer, comprising:

  providing a semiconductor wafer having a scribe mark;

  receiving light reflected from the scribe mark; and

  reflecting the light reflected from the scribe mark to a scribe mark reading area.
- 17. The method of claim 16, further including providing a source of light, wherein the light illuminates the semiconductor wafer.
- 18. The method of claim 16, wherein reflecting the light includes rectifying an image within the light.
  - 19. The method of claim 16, further including viewing the scribe marks on a plurality of wafers simultaneously.
- 30 20. The method of claim 16, further including using a camera to record images of the scribe marks.